SURFACE MOUNT SILICON HIGH CURRENT, LOW V_F SCHOTTKY DIODE





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMPSH05-4 is a high current, low V_F 40 volt Schottky diode packaged in a space saving SOT-23 surface mount case. This device has been designed for small signal general purpose applications when small size and operational efficiency are prime requirements.

MARKING CODE: C054

FEATURES:

- Low V_F = 0.35V max @ 100mA
- V_{RRM} = 40V
- I_F = 500mA

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Continuous Forward Current	١ _F	500	mA
Peak Repetitive Forward Current, tp≤1.0ms	IFRM	3.5	А
Peak Forward Surge Current, tp=8.0ms	IFSM	10	А
Power Dissipation	PD	350	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	357	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

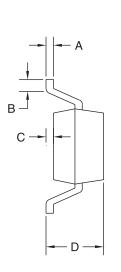
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I _R	V _R =10V		30	μA
I _R	V _R =30V		100	μA
вv _R	Ι _R =500μΑ	40		V
VF	I _F =100μΑ		0.13	V
V _F	I _F =1.0mA		0.21	V
V _F	I _F =10mA		0.27	V
V _F	I _F =100mA		0.35	V
V _F	I _F =500mA		0.47	V
СЈ	V _R =1.0V, f=1.0MHz		50	pF

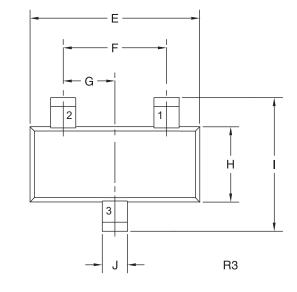
R3 (8-January 2018)



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SOT-23 CASE - MECHANICAL OUTLINE





LEAD CODE: 1) Anode 2) No Connection

3) Cathode

MARKING CODE: C054

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
А	0.003	0.007	0.08	0.18			
В	0.006	-	0.15	-			
С	-	0.005	-	0.13			
D	0.035	0.043	0.89	1.09			
E	0.110	0.120	2.80	3.05			
F	0.075		1.90				
G	0.037		0.95				
Н	0.047	0.055	1.19	1.40			
	0.083	0.098	2.10	2.49			
J	0.014	0.020	0.35	0.50			

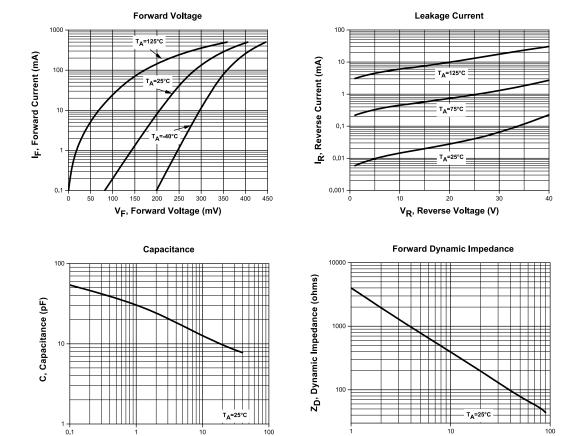
SOT-23 (REV: R3)

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TYPICAL ELECTRICAL CHARACTERISTICS

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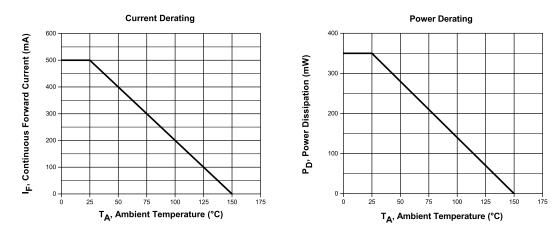
V_R, Reverse Voltage (V)

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IF, Forward Current (mA)



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TYPICAL ELECTRICAL CHARACTERISTICS

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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